# SMF3.3

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#### Agency Approvals

AGENCY	AGENCY FILE NUMBER
<b>91</b>	E230531

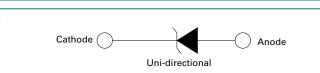
#### **Maximum Ratings and Thermal Characteristics** (T<sub>4</sub>=25°C unless otherwise noted)

Parameter		Symbol	Value	Unit
Peak Pulse Power	8/20µs	р	1200	W
Dissipation at T <sub>A</sub> =25°C (Note 1)	10/1000µs	P <sub>PPM</sub>	200	W
Thermal Resistance Ambient	e Junction- to-	R <sub>eja</sub>	220	°C/W
Thermal Resistanc	e Junction- to- Lead	$R_{_{\theta JL}}$	100	°C/W
Operating Temper	ature Range	TJ	-55 to 150	°C
Storage Temperatu	ire Range	T <sub>stg</sub>	-55 to 150	°C

#### Notes:

1. Non-repetitive current pulse, per Fig. 4 & 6 and derated above T, (initial) =25°C per Fig. 3.

#### **Functional Diagram**



## Description

SMF3.3 is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

#### **Features**

- 200W peak pulse power capability at 10/1000µs waveform, repetition rate (duty cycle): 0.01%
- 1200W peak pulse power capability at 8/20us waveform
- Excellent clamping capability
- Compatible with industrial standard package SOD-123FL
- Low profile: maximum height of 1.08mm.
- For surface mounted applications to optimize board space
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 30kV(Air), 30kV (Contact)

#### ESD protection of data lines in accordance with IEC 61000-4-2

- EFT protection of data lines in accordance with IEC 61000-4-4
- Fast response time: typically less than 1.0ns from 0 Volts to  $V_{BR}$  min
- High temperature soldering: 260°C/40 seconds at terminals
- Built-in strain relief
- Meet MSL level1, per J-STD-020C, LF maximun peak of 260°C
- Matte tin lead-free plated
- Halogen-free and RoHS compliant
- Pb-free E3 means 2<sup>nd</sup> level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/ JEDEC J-STD-609A.01)

#### Applications

SMF3.3 devices are ideal for the protection of portable devices/hard drives, notebooks,  $\mathrm{V}_{\mathrm{cc}}$  busses, POS terminal, SSDs, power supplies, monitors, and vulnerable circuit used in other consumer applications.

Electrica	al Charact	teristics	์ (T <sub>A</sub> =25°C เ	unless other	wise noted)					
Part Number	Marking Code	Voltaç	down ge V <sub>BR</sub> a) @ I <sub>T</sub>	Test Current	Reverse Stand off Voltage V <sub>e</sub>	Maximum Reverse Leakage @ V₅	Maximum Peak Pulse Current	Maximum Clamping Voltage @l	Maximum Peak Pulse Current	Maximum Clamping Voltage @l
		MIN	MAX	'⊤ (mA)	(V)	I <sub>R</sub> (μΑ)	(10/1000µS) I <sub>pp</sub> (A)	(10/1000µŠ) V <sub>c</sub> (V)	(8/20µS) I <sub>pp</sub> (A)	(8/20µS) <sup>⊷</sup> V <sub>c</sub> (V)
SMF3.3	33	3.4	4.3	10	3.3	0.5	30.0	6.8	120.0	10.0

#### Notes:

 $V_{pp}$  measured after I<sub>T</sub> applied for 300µs, I<sub>T</sub> = sequare wave pulse or equivalent.

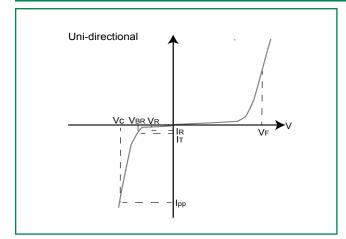
Surge current waveform per 10/1000µs exponential wave and derated per Fig.2.

All terms and symbols are consistent with ANSI/IEEE C62.35.
 Surge current waveform per 8/20µs exponential wave and derated per Fig.6

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#### **I-V Curve Characteristics**



- $\textbf{P}_{_{\textbf{PPM}}}$  Peak Pulse Power Dissipation Max power dissipation
- $\mathbf{V}_{_{\!R}}$  **Stand-off Voltage** Maximum voltage that can be applied to the TVS without operation
- V<sub>BR</sub> Breakdown Voltage -- Maximum voltage that flows though the TVS at a specified test current (I,)
- V<sub>c</sub> Clamping Voltage Peak voltage measured across the TVS at a specified lppm (peak impulse current)
- ${\boldsymbol{I}}_{\!\scriptscriptstyle \rm R}$  Reverse Leakage Current -- Current measured at  $V_{\!\scriptscriptstyle \rm R}$
- V<sub>F</sub> Forward Voltage Drop for Uni-directional

note:  $V_{E}$  distribution range from 10V to 15V

#### Ratings and Characteristic Curves (T<sub>A</sub>=25°C unless otherwise noted)

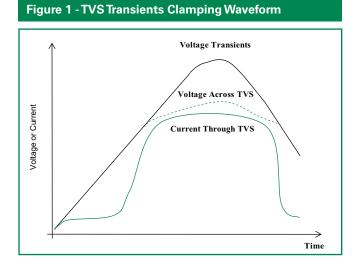


Figure 3 - Peak Pulse Power Derating Curve

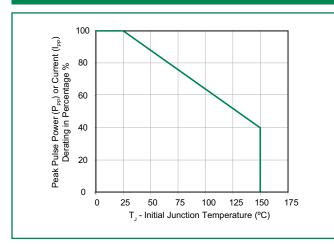
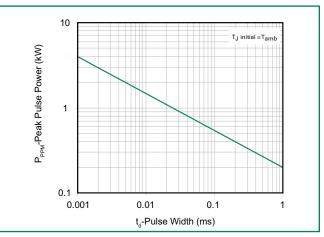
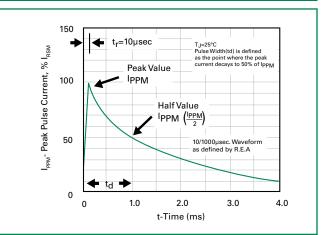


Figure 2 - Peak Pulse Power Rating Curve



#### Figure 4 - 10/1000µS Pulse Waveform



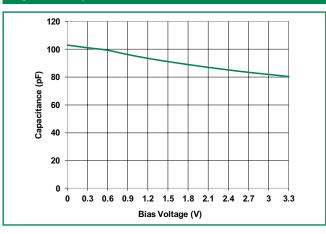
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Surface Mount – 200W > SMF3.3 Series

#### Figure 5 - Capacitance vs. Reverse Bias

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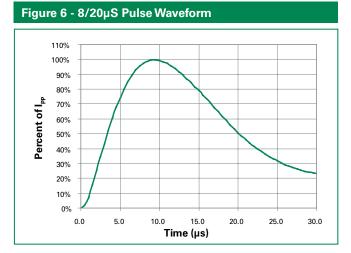


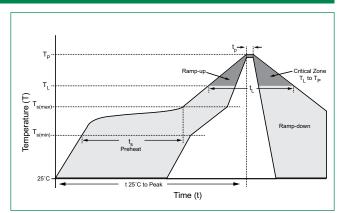
#### **Soldering Parameters**

Reflow Co	ndition	Lead–free assembly
	-Temperature Min (T <sub>s(min)</sub> )	150°C
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C
	-Time (min to max) (t <sub>s</sub> )	60 – 180 secs
Average ra to peak	mp up rate (Liquidus Temp (T <sub>A</sub> )	3°C/second max
$T_{S(max)}$ to $T_A$	- Ramp-up Rate	3°C/second max
Reflow	-Temperature (T <sub>A</sub> ) (Liquidus)	217°C
nellow	-Time (min to max) (t <sub>s</sub> )	60 – 150 seconds
Peak Temp	erature (T <sub>P</sub> )	260+0/-5 °C
Time withi Temperatu	n 5°C of actual peak re (t <sub>p</sub> )	20 – 40 seconds
Ramp-dow	n Rate	6°C/second max
Time 25°C	to peak Temperature (T <sub>P</sub> )	8 minutes Max.
Do not exc	eed	260°C

### **Physical Specifications**

Case	SOD-123FL plastic over passivated junction
Polarity	Color band denotes cathode except bipolar
Terminal	Matte tin-plated leads, solderable per JESD22-B102





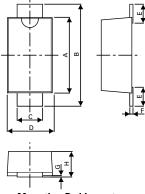
### **High Reliability Test Specification**

Pre-condition (HTRB/TC/ PCT/ H3TRB)	<ul> <li>(1) Bake 24hrs @150°C</li> <li>(2)168hrs @85% RH and 85°C</li> <li>(3) I<sub>R</sub> reflow,3 reflows, peak temperature of 260°C</li> </ul>
HTRB	JESD 22-108C V <sub>cc</sub> bias= 80%V <sub>DRM</sub> &T <sub>A</sub> =150°C, 1008hrs
Temperature Cycling	MIL-STD-883F, Method 1010.8 Condition C -65°C to150°C, 1000 cycles
Pressure Cooker	JEDEC 22-A102C 100%RH @121°C @15psi, 96hrs
Bias Humidity (H3TRB)	JESD 22-A101B Vcc bias (pin1to pin3)=V <sub>DRM</sub> ,85%RH, 85°C , 1008 hours
RSH	JESD 22-A111 260°C ,10 secs.

### TVS Diodes Surface Mount – 200W > SMF3.3 Series



#### Dimensions - SOD-123FL Package



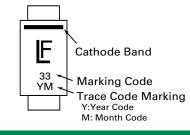
Dimensions	Millim	neters	Inches	
Dimensions	Min	Max	Min	Max
А	2.90	3.10	0.114	0.122
В	3.50	3.90	0.138	0.154
С	0.85	1.05	0.033	0.041
D	1.70	2.00	0.067	0.079
E	0.43	0.83	0.017	0.033
F	0.10	0.25	0.004	0.010
G	0.00	0.10	0.000	0.004
Н	0.90	1.08	0.035	0.043

**Mounting Pad Layout** 

 $V_{\rm R}$  VOLTAGE



### Part Marking System



#### **Packaging Options**

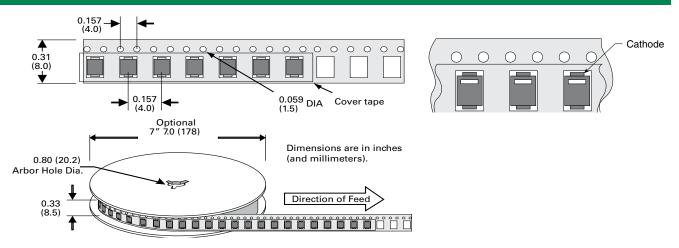
- SERIES

**Part Numbering System** 

SMF 3.3

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
SMF3.3	SOD-123FL	3000	Tape & Reel – 8mm tape/7" reel	EIA RS-481





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